



## Hi-Heat

### For high-fusing precious metals

- Flows freely into the smallest crevice
- Stacks and molds easily
- Sets moderately fast
- Trims smoothly
- Withstands rapid drying out

Hi-Heat Soldering Investment is a gypsum-bound investment that is ideal for any soldering job that requires the use of an oxygen-gas torch, or where an unusually fine and smooth soldering investment is wanted. Excellent for use with high-fusing ceramic alloys for both the pre- and post-soldering technique. Can also be used for soldering precision attachments.

## Physical Properties

Water/Powder Ratio	28 mL/100 g
Working Time	2–4 minutes
Ready for Dewaxing (Minimum)	20 minutes
Setting Expansion	0.20%
Thermal Expansion 700° C (1,300° F)	0.60%
Compressive Strength, Wet (2 hours)	300 psi (2 MPa)

## Item No. Description

01546	2 kg (4 1/2 lb.) Package
01562	11 kg (25 lb.) Carton